

## • General Description

The AGM15T06C-B combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

This device is ideal for load switch and battery protection applications.

#### Features

- Advance high cell density Trench technology
- Low R<sub>DS(ON)</sub> to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

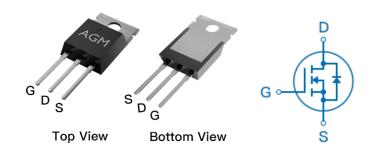
## Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

# **Product Summary**

BVDSS	RDSON	ID
140V	5.7mΩ	120A

## **TO-220 Pin Configuration**



## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM15T06C	AGM15T06C-B	TO-220			1000

## Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	140	V
VGS	Gate-Source Voltage (VDS=0V)		V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	120	А
	Drain Current-Continuous(Tc=100°ℂ)	85	А
IDM (pluse)	Drain Current-Pulsed (Note 2)	480	А
PD	Maximum Power Dissipation(Tc=25℃)	104	w
	Maximum Power Dissipation(Tc=100℃)	42	w
EAS	Avalanche energy (Note 3)	450	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$

## Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) <sup>1</sup>		50	°C/W
RθJC	Thermal Resistance Junction-Case <sup>1</sup>		1.2	°C/W



Table 3. Electrical Characteristics (TJ=25 ℃ unless otherwise noted)

Table 3.  Symbol	Electrical Characteristics (TJ=25℃ unle Parameter	Conditions	Min	Тур	Max	Unit
On/Off Sta				712		
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250µA	140	147		V
IDSS	Zero Gate Voltage Drain Current	VDS=140V,VGS=0V			1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	2		4	V
gFS	Forward Transconductance	VDS=5V,ID=15A		20		S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=20A		5.7	7.5	mΩ
Dynamic	Characteristics					
Ciss	Input Capacitance	VDS=40V,VGS=0V		3752		pF
Coss	Output Capacitance	F=1MHZ		1560		pF
Crss	Reverse Transfer Capacitance			47		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		0.8		Ω
Switching	Switching Times					
td(on)	Turn-on Delay Time			19		nS
tr	Turn-on Rise Time	VGS=10V,VDS=30V,		5		nS
td(off)	Turn-Off Delay Time	ID=40A,RGEN=2.5Ω RL=15Ω		24		nS
tf	Turn-Off Fall Time			10		nS
Qg	Total Gate Charge			57		nC
Qgs	Gate-Source Charge	VGS=10V, VDS=75V,		14		nC
Qgd	Gate-Drain Charge			11		nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)				120	А
VSD	Forward on Voltage	VGS=0V,IS=20A		0.9	1.2	V
trr	Reverse Recovery Time	IF=20A , dI/dt=100A/μs ,		85		ns
Qrr	Reverse Recovery Charge	TJ=25℃		120		nc

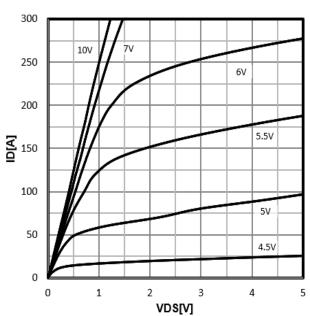
Notes 1. The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

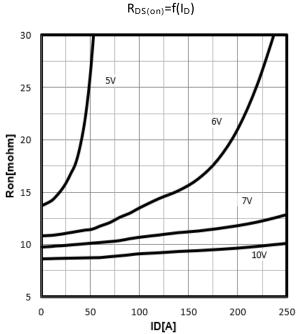
Notes 3.EAS condition: TJ=25 $^{\circ}$ C



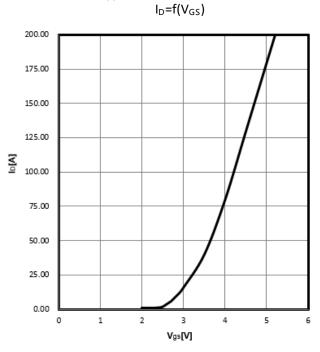
Typ. output characteristics  $I_D {=} f(V_{DS})$ 



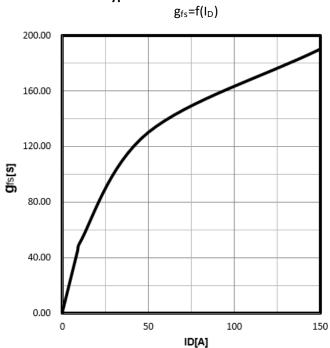
Typ. drain-source on resistance



Typ. transfer characteristics

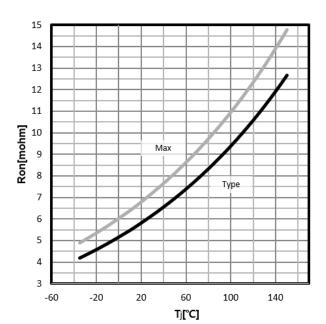


Typ. forward transconductance

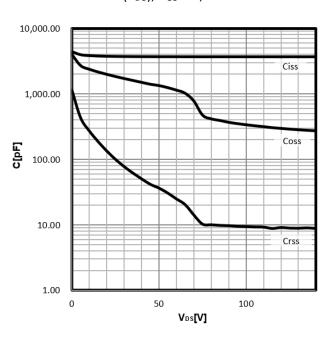




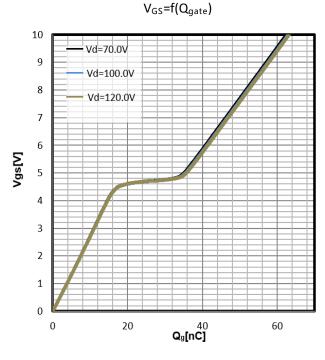
**Drain-source on-state resistance**  $R_{DS(on)}=f(T_j)$ ;  $I_D=20A$ ;  $V_{GS}=10V$ 



Typ. capacitances  $C = f(V_{DS}); V_{GS} = 0V; f = 1MHz$ 

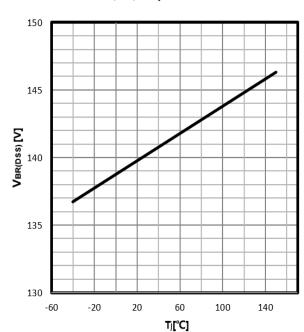


Typ. gate charge

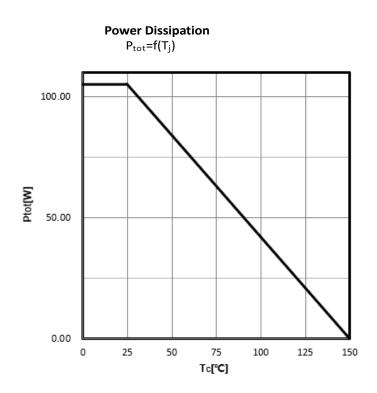


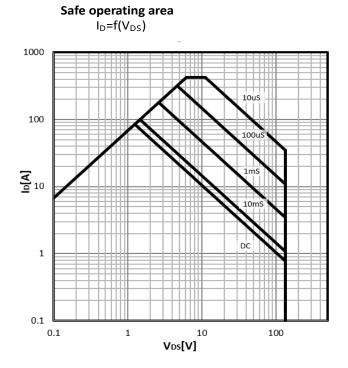
## Drain-source breakdown voltage

 $V_{BR(DSS)}=f(T_j); I_D=250uA$ 

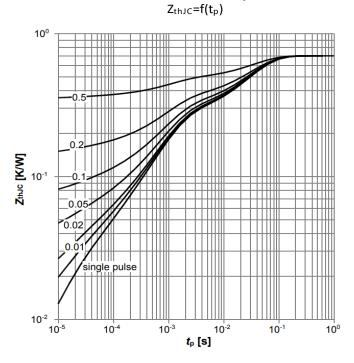






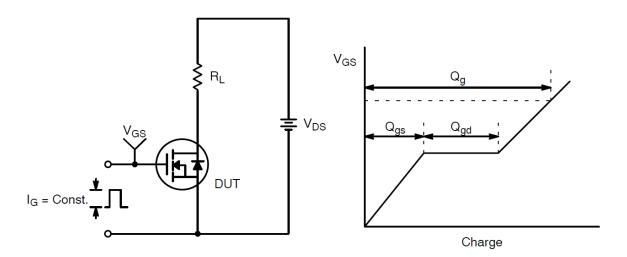


# Max. transient thermal impedance

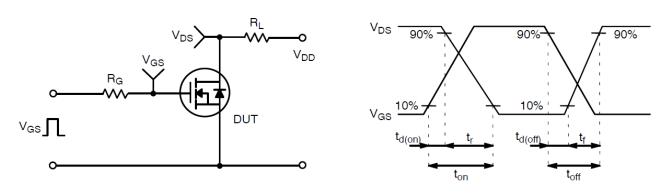




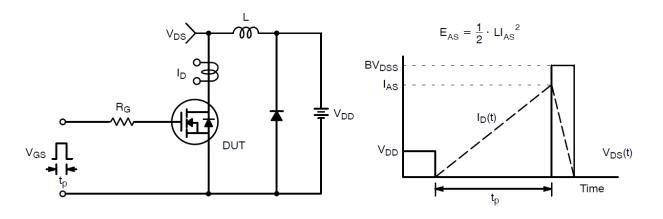
# **Test Circuit and Waveform:**



**Gate Charge Test Circuit & Waveform** 



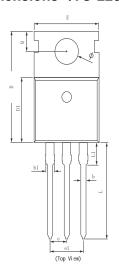
**Resistive Switching Test Circuit & Waveforms** 

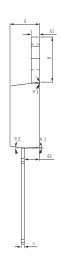


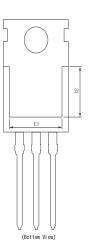
**Unclamped Inductive Switching Test Circuit & Waveforms** 



# •Dimensions (TO-220)

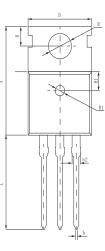


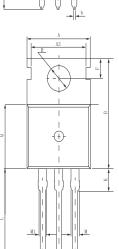




SYMBOL		MILLIMETER	
SIMDUL	MIN	Typ.	MAX
A	4.370	4.570	4.700
A1	1.250	1.300	1.400
A2	2. 150	2.350	2.550
b	0.700	0.800	0.950
b1	1.170	1.270	1.470
С	0.450	0.500	0.600
D	15. 100	15.600	16. 100
D1	8.800	9.100	9.400
D2	5. 500	6.300 REF	
E	9.700	10.000	10.300
E3	7.000	7.600 REF	
е	2.540 BSC		
e1		5.080 BSC	
L	13. 200	13.500	13.800
L1		3.100	3.400
Н	6.250	6.500	1.352
Φ	3.400	3.600	3.800
Q	2.600	2.800	3.000
θ 1	7° TYP		
θ 2	7° TYP		
θ 3	3° TYP		

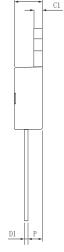


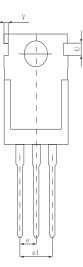


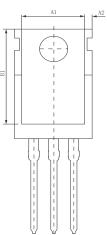












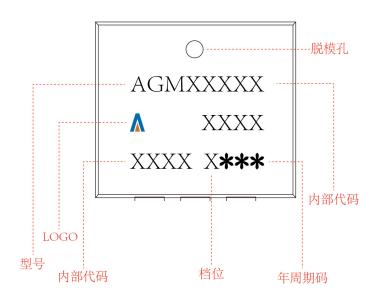
SYMBOL.		MILLIMETER	
BIMDOL	MIN	Typ.	MAX
A	15.400	15.600	15.800
A1	2.350	2.400	2.500
A2	4.400	4.500	4.700
b	0.700	0.800	0.900
b2	1.180	1.310	1.440
С	0.480	0.500	0.560
c1	1.290	1.300	1.320
D	9.800	10.000	10. 200
Е	6.400	6.500	6.600
E1	9.000	9.100	9.200
е	2. 420	2.540	2.660
el	4.840	5.080	5.320
Н	2.730	2.800	2.870
H1	2.400	2.500	2.600
L	13.020	13.370	13.720
R	3.500	3.600	3.730
R1	1.400	1.500	1.600
U	1.650	1.750	1.850
V	0.580	0.680	0.780
θ 1	2°	2.5°	3°
θ2	6.5°	7°	7.5°

Symbol	Dimensions (mm)
A	10.0±0.3
A1	8.0±0.2
A2	0.94±0.1
A3	8.7±0.1
В	15.6±0.4
B1	13.2±0.2
С	4.5±0.2
C1	1.3±0.2
D	0.8±0.2
D1	0.5±0.1
Е	10.0±0.3
F	2.8±0.1
Н	3.6±0.1
K	3.1±0.2
L	1.3±0.4
M	1.38±0.1
M1	1.28±0.1
N	2.54 (typ)
P	2.4±0.3
Q	9.15±0.25

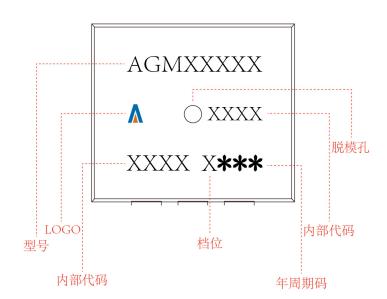


# TO-220 Marking Instructions:

# Model1:



# Model2:





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